

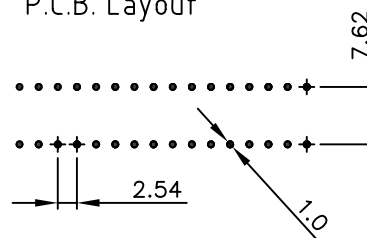
No. of Positions	DIM"A"	DIM"B"
6	7.62	5.08
8	10.16	7.62
14	17.78	15.24
16	20.32	17.78
18	22.86	20.32
20	25.40	22.86
24	30.48	27.94
28	35.56	33.02

**MATERIAL & FINISH**

- \* Contact: Beryllium Copper (BeCu)
- \* Sleeve: Brass
- Plating: G=Gold Plated  
T=Tin Plated

- \* Insulator: IC Socket=PPS
- \* Insertion Standard Force: Average 300 GR
- \* Extraction Standard Test: Average 60 GR
- \* Resist to Soldering Heat: Max. 120~130°C, 5 Sec.
- \* Current Rating: 1A
- \* Operating Humidity Range: Annual mean 75%
- \* Contact Resistance : 10 Milliohm
- \* Insulator Resistance : 5000 Mege Ohm at 500 VDC
- \* Dielectric Strength : 1000 VRMS Min
- \* Rated Voltage : 100 VRMS / 150VDC
- \* Temperature: - 55°C TO + 240°C

**P.C.B. Layout**



**RoHS Compliant**

TOLERANCES ARE



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DRAWING BY CY

CHECKED BY GENIUS

UNIT / mm

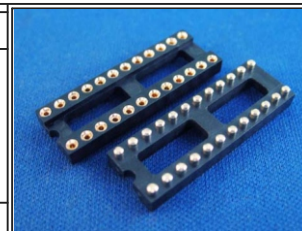
SCALE 1 : 1

DATE

SIZE A4

P PROJECTION

X, ±  
.X ±  
.XX ±  
.XXX ±  
ANG ±



**ORDER INFORMATION**

SICP-V03x-xx-LF

SERIES | LEADFREE  
06~32WAY  
G: GOLD  
T: TIN  
180°SMT SPACING 7.62mm

DESCRIPTION: